

General Description

The 100N03B uses advanced trench technology to provide excellent RDS(ON). This device is suitable for low voltage, high speed switching applications in power supplies.

Product Summary

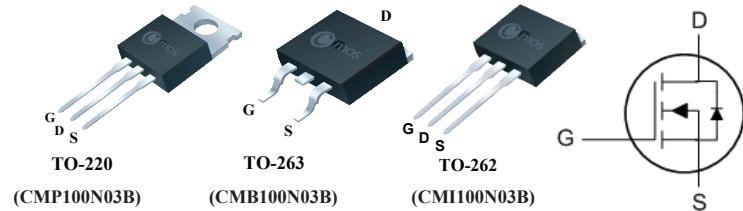
BVDSS	RDSON	ID
30V	4.5mΩ	100A

Applications

- High current, High speed switching
- DC-DC & DC-AC Converters
- Motor control Audio amplifiers
- Solenoid and relay drivers
- Automotive environment

Features

- Simple Drive Requirement
- Fast Switching
- Low On-Resistance

TO-220/263/262 Pin Configuration**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current	100	A
$I_D @ T_c = 100^\circ C$	Continuous Drain Current	70	A
I_{DM}	Pulsed Drain Current	300	A
EAS	Single Pulse Avalanche Energy ¹	250	mJ
P_D	Total Power Dissipation	300	W
T_{STG}	Storage Temperature Range	-55 to 175	°C
T_J	Operating Junction Temperature Range	-55 to 175	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.5	°C/W

Electrical Characteristics (T_J=25°C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30	---	---	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =30A	---	4	4.5	mΩ
		V _{GS} =4.5V , I _D =20A	---	5	6	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1	---	2	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =30V , V _{GS} =0V	---	---	1	uA
		V _{DS} =30V , V _{GS} =0V , TC=125°C	---	---	100	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA
g _{fs}	Forward Transconductance	I _D =22A V _{DS} =10V	---	25	---	S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	---	7	---	Ω
Q _g	Total Gate Charge	I _D =100A	---	85	---	nC
Q _{gs}	Gate-Source Charge	V _{DD} =24V	---	21	---	
Q _{gd}	Gate-Drain Charge	V _{GS} =10V	---	40	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =15V	---	15	---	ns
T _r	Rise Time	I _D =100A	---	70	---	
T _{d(off)}	Turn-Off Delay Time	R _G =1.1Ω	---	85	---	
T _f	Fall Time	V _{GS} =10V	---	65	---	
C _{iss}	Input Capacitance	V _{DS} =25V , V _{GS} =0V , f=1MHz	---	3100	---	pF
C _{oss}	Output Capacitance		---	1400	---	
C _{rss}	Reverse Transfer Capacitance		---	440	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	100	A
I _{SM}	Pulsed Source Current		---	---	300	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =25A , T _J =25°C	---	---	1.3	V

Note :

3.The EAS data shows Max. rating . The test condition is V_{DD}=20V,V_{GS}=10V,L=1mH,I_{AS}=22.5A

This product has been designed and qualified for the consumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design ,functions and reliability without notice.